SQ4917EY



Vishay Siliconix

Automotive Dual P-Channel 60 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	-60			
$R_{DS(on)}$ (Ω) at V_{GS} = -10 V	0.0480			
$R_{DS(on)}$ (Ω) at V_{GS} = -4.5 V	0.0612			
I _D (A) per leg	-8			
Configuration	Dual			

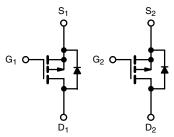


FEATURES

- TrenchFET® power MOSFET
- AEC-Q101 qualified ^c
- 100 % R_g and UIS tested
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>



RoHS COMPLIANT HALOGEN FREE



P-Channel MOSFET P-Channel MOSFET

ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free and Halogen-free	SQ4917EY-T1-GE3			

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V _{DS}	-60			
Gate-Source Voltage	V _{GS}	± 20	V		
Continuous Drain Current	T _C = 25 °C	I _D	-8		
Continuous Drain Current	T _C = 125 °C		-4.75		
Continuous Source Current (Diode Conduction)	I _S	-4.5	А		
Pulsed Drain Current ^a		I _{DM}		-32	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	-22.4		
Single Pulse Avalanche Energy		E _{AS}	25	mJ	
Manimum Danier Diagin ation 2	T _C = 25 °C	PD	5	W	
Maximum Power Dissipation ^a	T _C = 125 °C		1.67	vv	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount ^b	R _{thJA}	110	°C/W	
Junction-to-Foot (Drain)		R _{thJF}	30	0/11	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. When mounted on 1" square PCB (FR-4 material).

c. Parametric verification ongoing.

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PARAMETER Static Drain-Source Breakdown Voltage Gate-Source Threshold Voltage Gate-Source Leakage	V _{DS} V _{GS(th)} I _{GSS}	V _{GS} = V _{DS} = V _{DS} =	T CONDITIONS = 0 V, I _D = -250 μA V _{GS} , I _D = -250 μA	-60 -1.5	TYP.	MAX.	UNIT
Drain-Source Breakdown Voltage Gate-Source Threshold Voltage Gate-Source Leakage	V _{GS(th)} I _{GSS}	V _{DS} = V _{DS} =	V_{GS} , I_D = -250 μ A		-		
Gate-Source Threshold Voltage Gate-Source Leakage	V _{GS(th)} I _{GSS}	V _{DS} = V _{DS} =	V_{GS} , I_D = -250 μ A		-		
Gate-Source Leakage	I _{GSS}	V _{DS} =		-1.5		-	v
°		_			-2.0	-2.5	
	Inco		0 V, $V_{GS} = \pm 20 V$	-	-	± 100	nA
	Inco	$V_{GS} = 0 V$	V _{DS} = -60 V	-	-	-1	
Zero Gate Voltage Drain Current	-055	$V_{GS} = 0 V$	$V_{DS} = -60 \text{ V}, \text{T}_{\text{J}} = 125 ^{\circ}\text{C}$	-	-	-50	μA
		$V_{GS} = 0 V$	V_{DS} = -60 V, T_J = 175 °C	-	-	-150	
On-State Drain Current ^a	I _{D(on)}	V_{GS} = -10 V	$V_{DS} \le -5 V$	-30	-	-	А
		$V_{GS} = -10 V$	I _D = -4.3 A	-	0.0400	0.0480	
Durin Country On Otata Dariatana a 3	R _{DS(on)}	$V_{GS} = -10 \text{ V}$	$I_D = -4.3 \text{ A}, \text{ T}_J = 125 ^\circ\text{C}$	-	-	0.0780	Ω
Drain-Source On-State Resistance ^a		$V_{GS} = -10 \text{ V}$	I _D = -4.3 A, T _J = 175 °C	-	-	0.0960	
		$V_{GS} = -4.5 V$	I _D = -3.8 A	-	0.0510	0.0612	
Forward Transconductance b	9 _{fs}	V _{DS} = -15 V, I _D = -4.3 A		-	13	-	S
Dynamic ^b							
Input Capacitance	C _{iss}		V _{DS} = -30 V, f = 1 MHz	-	1530	1910	pF
Output Capacitance	C _{oss}	$V_{GS} = 0 V$		-	334	417	
Reverse Transfer Capacitance	C _{rss}			-	114	142	
Total Gate Charge ^c	Qg			-	43.4	65	
Gate-Source Charge ^c	Q _{gs}	V _{GS} = -10 V	$V_{DS} = -30 \text{ V}, \text{ I}_{D} = -5 \text{ A}$	-	4.7	-	nC
Gate-Drain Charge ^c	Q _{gd}				9	-	1
Gate Resistance	R _g		f = 1 MHz		2.5	4	Ω
Turn-On Delay Time ^c	t _{d(on)}			-	11	17	
Rise Time ^c	tr	$V_{DD} = -30 \text{ V}, \text{ R}_{\text{L}} = 8.8 \Omega$ $\text{I}_{\text{D}} \cong -5 \text{ A}, \text{ V}_{\text{GEN}} = -10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		-	11	17	
Turn-Off Delay Time ^c	t _{d(off)}			-	35	52	- ns
Fall Time ^c	t _f			-	6	9	
Source-Drain Diode Ratings and Characteristics ^b							
Pulsed Current ^a	I _{SM}			-	-	-32	А
Forward Voltage	V _{SD}	I _F =	-2.8 A, V _{GS} = 0 V	-	-0.8	-1.2	V

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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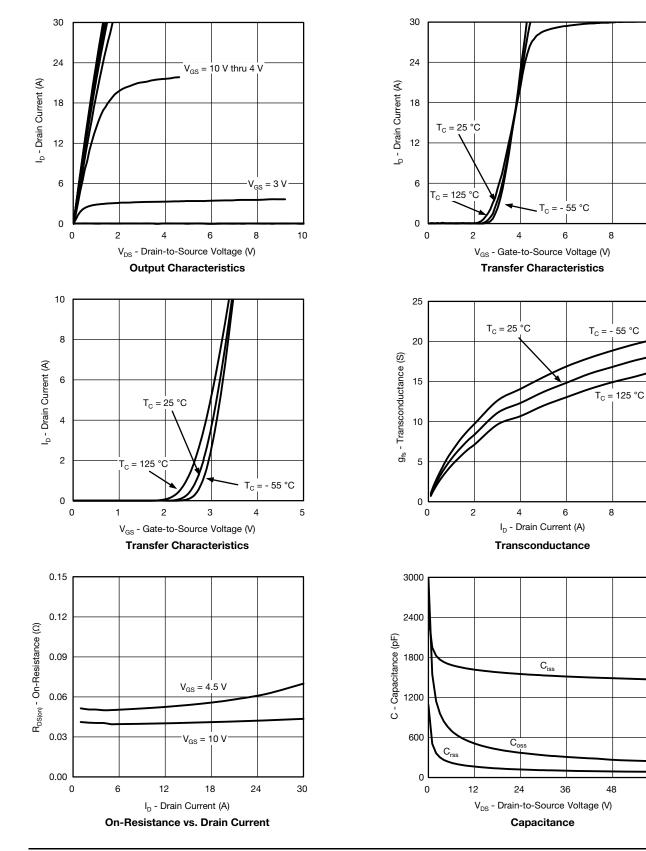


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TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



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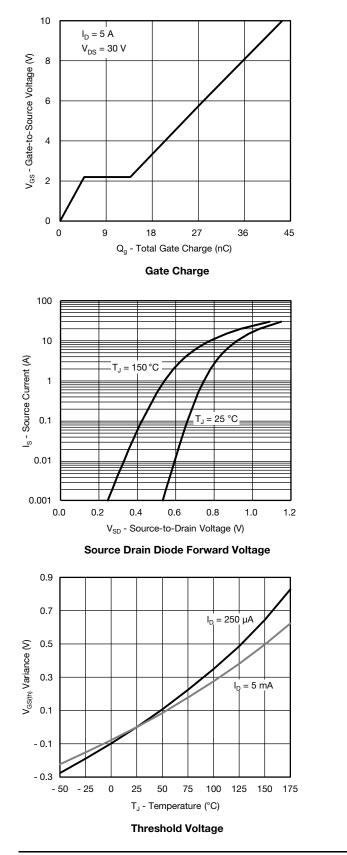
Document Number: 62785

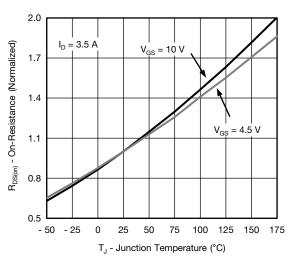
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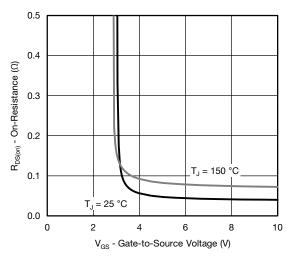


TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

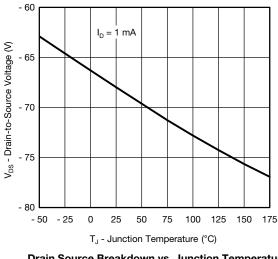




On-Resistance vs. Junction Temperature







Drain Source Breakdown vs. Junction Temperature

S14-1010-Rev. B, 19-May-14

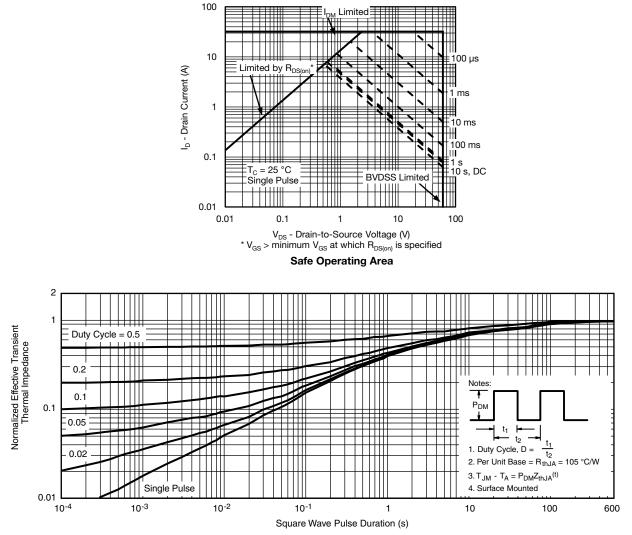
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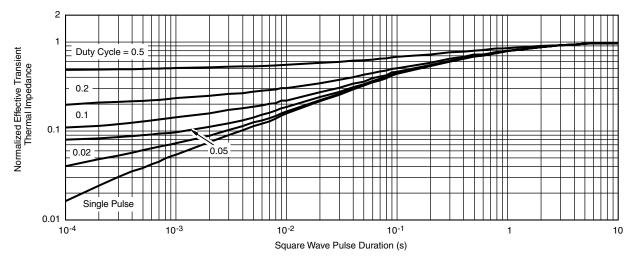
THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Note

The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Foot (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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REVISION HISTORY^a

REVISION	DATE	DESCRIPTION OF CHANGE	
В	04-Apr-14	 Corrected on-resistance vs. junction temperature graph, normalized at 1 = 25 °C instead of 75 °C 	

Note

a. As of April 2014



SO-8

Ordering codes for the SQ rugged series power MOSFETs in the SO-8 package:

DATASHEET PART NUMBER	OLD ORDERING CODE ^a	NEW ORDERING CODE	
SQ4005EY	-	SQ4005EY-T1_GE3	
SQ4050EY	SQ4050EY-T1-GE3	SQ4050EY-T1_GE3	
SQ4182EY	SQ4182EY-T1-GE3	SQ4182EY-T1_GE3	
SQ4184EY	SQ4184EY-T1-GE3	SQ4184EY-T1_GE3	
SQ4282EY	SQ4282EY-T1-GE3	SQ4282EY-T1_GE3	
SQ4284EY	SQ4284EY-T1-GE3	SQ4284EY-T1_GE3	
SQ4401EY	SQ4401EY-T1-GE3	SQ4401EY-T1_GE3	
SQ4410EY	SQ4410EY-T1-GE3	SQ4410EY-T1_GE3	
SQ4425EY	SQ4425EY-T1-GE3	SQ4425EY-T1_GE3	
SQ4431EY	SQ4431EY-T1-GE3	SQ4431EY-T1_GE3	
SQ4435EY	SQ4435EY-T1-GE3	SQ4435EY-T1_GE3	
SQ4470EY	SQ4470EY-T1-GE3	SQ4470EY-T1_GE3	
SQ4483BEEY	SQ4483BEEY-T1-GE3	SQ4483BEEY-T1_GE3	
SQ4483EY	-	SQ4483EY-T1_GE3	
SQ4532AEY	-	SQ4532AEY-T1_GE3	
SQ4840EY	SQ4840EY-T1-GE3	SQ4840EY-T1_GE3	
SQ4850EY	SQ4850EY-T1-GE3	SQ4850EY-T1_GE3	
SQ4917EY	SQ4917EY-T1-GE3	SQ4917EY-T1_GE3	
SQ4920EY	SQ4920EY-T1-GE3	SQ4920EY-T1_GE3	
SQ4937EY	SQ4937EY-T1-GE3	SQ4937EY-T1_GE3	
SQ4940AEY	SQ4940AEY-T1-GE3	SQ4940AEY-T1_GE3	
SQ4946AEY	SQ4946AEY-T1-GE3	SQ4946AEY-T1_GE3	
SQ4949EY	SQ4949EY-T1-GE3	SQ4949EY-T1_GE3	
SQ4961EY	SQ4961EY-T1-GE3	SQ4961EY-T1_GE3	
SQ9407EY	SQ9407EY-T1-GE3	SQ9407EY-T1_GE3	
SQ9945BEY	SQ9945BEY-T1-GE3	SQ9945BEY-T1_GE3	

Note

a. Old ordering code is obsolete and no longer valid for new orders



Package Information

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





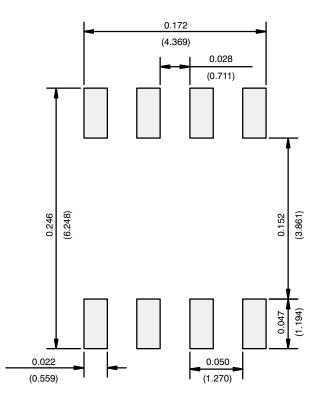
	MILLIM	IETERS	INC	HES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

Application Note 826

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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